

SCHEDULE 2

Regulation 4(2)

Exempt applications

1. Mercury in compact fluorescent lamps not exceeding 5 mg per lamp.
2. Mercury in straight fluorescent lamps for general purposes not exceeding
 - (a) 10 mg for halophosphate,
 - (b) 5mg for triphosphate with normal lifetime, and
 - (c) 8 mg for triphosphate with long lifetime.
3. Mercury in straight fluorescent lamps for special purposes.
4. Mercury in other lamps not specifically mentioned in this Schedule.
5. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.
6. Lead as an alloying element in steel containing up to 0.35% lead by weight, aluminium containing up to 0.4% lead by weight and as a copper alloy containing up to 4% lead by weight.
7. Lead—
 - (a) in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85% lead),
 - (b) in solders for servers, storage and storage array systems,
 - (c) in solders for network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunication, and
 - (d) in electronic ceramic parts (eg piezoelectronic devices).
8. Cadmium plating except for applications banned under Directive [91/338/EEC](#)(1) amending Directive [76/769/EEC](#)(2) relating to restrictions on the marketing and use of certain dangerous substances and preparations.
9. Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators.

(1) OJNo. L 186, 12.7.1991, p.59.

(2) OJ No. L 262, 27.9.1976., p.201.